

2.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Features

- Guard Ring Die Construction for Transient Protection
- Ideally Suited for Automated Assembly
- Low Power Loss, High Efficiency
- Surge Overload Rating to 50A Peak
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Application
- High Temperature Soldering: 260°C/10 Second at Terminal
- Lead Free Finish/RoHS Compliant (Note 1)
- Green Molding Compound (No Halogen and Antimony) (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SMA/SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band or Cathode Notch
- Weight: SMA 0.064 grams (Approximate) SMB 0.093 grams (Approximate)





Top View

Bottom View

Ordering Information (Note 3)

Part Number	Qualification	Case	Packaging
B2xxA-13-F	Commercial	SMA	5000/Tape & Reel
B2xx-13-F	Commercial	SMB	3000/Tape & Reel
B250Q-13-F	Automotive	SMB	3000/Tape & Reel

^{*} x = Device type, e.g. B260A-13-F (SMA package); B240-13-F (SMB package).

Notes:

- 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
- 2. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



B2X0A = Product type marking code, ex: B220A (SMA package)
B2X0 = Product type marking code, ex: B230 (SMB package)

| | = Manufacturers' code marking

YWW = Date code marking

Y = Last digit of year (ex: 2 for 2002)

WW = Week code (01 to 53)



Maximum Ratings @TA = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	B220/A	B230/A	B240/A	B250/A	B260/A	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	20	30	40	50	60	V
RMS Reverse Voltage	V _{R(RMS)}	14	21	28	35	42	V
Average Rectified Output Current @ T _L = 100°C	lo			2.0			Α
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load				50			А

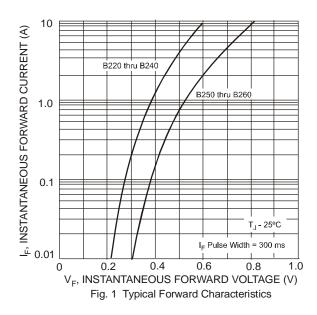
Thermal Characteristics

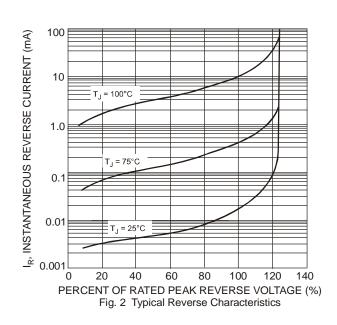
Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Lead SMA SMB	$R_{ hetaJL}$	25 20	°C/W
Operating and Storage Temperature Range	$T_{J_1}T_{STG}$	-65 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

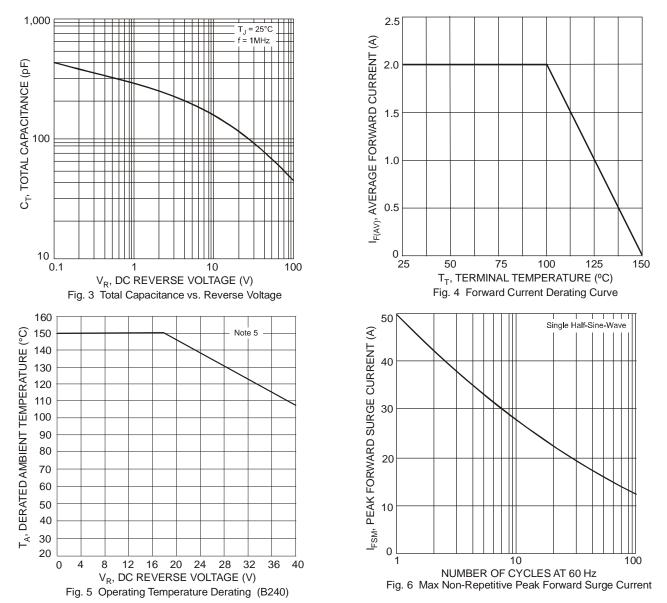
Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	B220/A, B230/A, B240/A B250/A, B260/A	V_{F}	ı	ı	0.50 0.70	>	I _F = 2.0A, T _A = 25°C
Leakage Current (Note 4)		I_R	1 1	1 1	0.5 20	m A	 @ Rated V_R, T_A = 25°C @ Rated V_R, T_A = 100°C
Total Capacitance		C_T	ı	-	200	pF	$V_R = 4V, f = 1MHz$

Notes: 4. Short duration pulse test used to minimize self-heating effect.



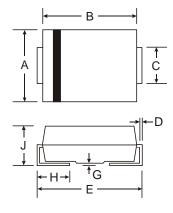






5. Device mounted on FR-4 PC board with minimum recommended pad layout pattern as per http://www.diodes.com/datasheets/ap02001.pdf.

Package Outline Dimensions

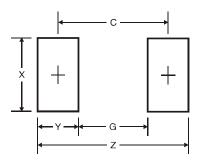


SMA		
Dim	Min	Max
Α	2.29	2.92
В	4.00	4.60
С	1.27	1.63
D	0.15	0.31
Е	4.80	5.59
G	0.05	0.20
Н	0.76	1.52
J	2.01	2.30
All Dim	ensions	in mm

SMB				
Dim	Min	Max		
Α	3.30	3.94		
В	4.06	4.57		
C	1.96	2.21		
D	0.15	0.31		
Е	5.00	5.59		
G	0.05	0.20		
H	0.76	1.52		
J	2.00	2.50		
All Dimensions in mm				



Suggested Pad Layout



SMA Dimensions	Value (in mm)		
Z	6.5		
G	1.5		
Х	1.7		
Y	2.5		
С	4.0		

SMB Dimensions	Value (in mm)
Z	6.7
G	1.8
Х	2.3
Y	2.5
С	4.3

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